IPC ASSOCIATION CON	Material Com © Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
Supplier In	formation														
Company name* Company uniqu				que ID Uniqu			Unique ID Authority				Respon	Response Date*			
nsemi											2023-06	2023-06-08			
Contact Name	9	Title - Contact			]	Phone - Contact*				Email - Contact*					
Product-Env-	Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Re	epresentative*	Title - Representative			]	Phone - Representative*				Email - Representative*					
Product-Env-	-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Re	equester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Versio	n :	Manufacturing Site		Weight*	UOM	Unit Type	
		LC749000AT-8B15H Video processor for		or LCD		2023-06-08	PHM			500.0	mg	Each			
Ianufactu	ring Proccess Informa	ation													
Ten	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-0		-STD-020 MS	SL Rating	Peak Process Body Tempera		Temperatu	re Max Time at Peak	Tempera	ture Numb	er of Reflow Cyc	eles	
contains Bi		CU Alloy 3			260 C 30		30	seconds 3							
omments															
TTENTION	: MSL 3 Rated item requir	es Bake and D	ry Pack (after	electrical test)											
or more info	rmation regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	16.17	mg	Supplier	Silicon (Si)	7440-21-3		16.1134	mg
			Supplier	Polyimide	Proprietary Data		0.0566	mg
Die Attach	3.91	mg	Supplier	Silver (Ag)	7440-22-4		2.7761	mg
			Supplier	Epoxy resins	129915-35-1		1.1339	mg
Lead Frame	150.76	mg	Supplier	Silver (Ag)	7440-22-4		0.7538	mg
			Supplier	Tin (Sn)	7440-31-5		1.8694	mg
			Supplier	Zinc (Zn)	7440-66-6		0.4372	mg
			Supplier	Silicon (Si)	7440-21-3		1.0402	mg
			В	Nickel (Ni)	7440-02-0		4.7942	mg
			Supplier	Copper (Cu)	7440-50-8		141.8652	mg
Mold Compound-Black	324.26	mg		Organic Phosphorus compound	proprietary data		4.5396	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		26.5893	mg
			Supplier	Carbon Black (C)	1333-86-4		0.6485	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		292.4825	mg
Plating	0.5	mg	В	Bismuth (Bi)	7440-69-9		0.003	mg
			Supplier	Tin (Sn)	7440-31-5		0.497	mg
Wire Bond	4.4	mg	Supplier	Palladium (Pd)	7440-05-3		0.044	mg
			Supplier	Gold (Au)	7440-57-5		4.356	mg